PATENT ASSIGNMENT

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SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Mi Young KIM	11/30/2009

RECEIVING PARTY DATA

Name:	Dongbu HiTek Co., Ltd.
Street Address:	891-10, Daechi-dong, Kangnam-ku
City:	Seoul
State/Country:	REPUBLIC OF KOREA

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12628119

CORRESPONDENCE DATA

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Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: (559)432-6847

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Correspondent Name: Andrew D. Fortney

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ATTORNEY DOCKET NUMBER: OPP-GZ-2009-0071-US-00

NAME OF SUBMITTER: Andrew D. Fortney, Reg. No. 34,600

Total Attachments: 1

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OF \$40.00 126281

PATENT REEL: 023582 FRAME: 0236 Attorney Docket No.: OPP-GZ-2009-0071-US-00

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, the undersigned,

Mi Young KIM

who have created a certain invention for which an application for United States Letters Patent was executed by me concurrently herewith and entitled:

Semiconductor Device and Method of Manufacturing the Same

Do hereby sell, assign and transfer to of Republic of Korea , having a place of business at 891-80, Duechi-dong, Kangman-lon, Seoul / Republic of Korea , having a place of business successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries, and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the informational conventions, unions, agreements, acts, and treaties; Agree that Doughu Hittak Co., Ltd. hereinafter referred to as Assignes, may apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to as assigney to many apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to as assigneed, as the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, execute all rightful onto, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said invention and the history fluereof; and generally do everything possible which said Assignee, its successors, assigns, or legal representatives and all applications for patents on said invention in said Assignee, its successors, assigns, or legal representatives; and conversed to their by the undersigned, and that full right t
891-14, Deschi-dong, Kaugnam-lon, Seoul / Republic of Korea its successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessious and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filled in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the informational conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties; Agree that Doughu HiTek Co., Ltd. hereinafter referred to as Assignee, may apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to as said invention, in its own name, in the United States, its territorial possessions, and all foreign countries and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in- part, continuations, divisions, substitutes, reissues, extensions thereof, execute all rightful ontos, assignments, powers of attorney and other pagers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns or legal representatives all facts known to tendersigned relating to said invention and the bishory thereof; and generally do everything possible which said Assignee, its successors, assigns, or legal representatives; and Covenant with said Assignee, its success
its successors, assigns, and legal representatives, the full and exclusive right to said invention and application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted theoretor in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the informational conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties, acts, and treaties, and treaties, and the long the HTek Co., Ltd. Agree that Doughu HTek Co., Ltd. Agree that Doughu HTek Co., Ltd. Assigne, its successors, assigns and legal representatives, the undersigned will execute all countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations in part, continuations, divisions, substitutes, reissues, extensions thereof, execute all rightful ontos, assignments, powers of attorney and other pagers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns or legal representatives all faces known to the undersigned relating to said invention and the bissory thereof, and generally do everything possible which said Assignee, its successors, assigns, or legal representatives that no assignment, powers of attorney and other pagers, testing the rights and property berein conveyed has been made to others by the undersigned, and that f
Agree that Boughu HiTek Co., Ltd.
invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for verting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns, or legal representatives; and Covenant with said Assignee, its successors, assigns, or legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property hereia conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned. IN TESTIMONY WHEREOF I have hereunto set MY signature on the date indicated below.
mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned. IN TESTIMONY WHEREOF I have hereunto set MY algustane on the date indicated below.
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Lan Lander as traction .
Mi Young KIM
Inventor's Signature: Date: Month/Day/Year
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X
Full Name of Second Inventor, if any:
Inventor's Signature: Date: Mon(lt/Day/Year

Customer No. 36872

RECORDED: 11/30/2009

REEL: 023582 FRAME: 0237